Document Number: GTAH58012C6 Preliminary Datasheet V1.0

GaN HEMT 28V, 5.8GHz 12W, RF Power Transistor Description

The GTAH58012C6 is a 12W GaN HEMT, designed for ISM/RF Energy application around 5.8GHz. The transistor is available in a highly cost effective 10*6mm, surface mount, QFN package with 100% production test to ensure the quality and consistency.

It can be used in CW, Pulse and any other modulation modes.

Typical Class AB RF Performance with device soldered through high density and plated grounding vias CW, Vds=28V, Idq=20mA

OVV, VGO 20V, IC	577, 745 257, 149 25117.						
Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
5100	40.31	10.75	52.35	15.06	41.58	14.39	56.03
5200	40.46	11.11	52.78	14.77	41.46	14	55.44
5300	40.53	11.31	52.73	14.33	41.37	13.72	54.61
5400	40.55	11.35	52.03	14.38	41.43	13.89	54.14
5500	40.38	10.92	50.71	14.53	41.59	14.4	54.24
5600	40.39	10.95	49.63	14.18	41.59	14.43	53.73
5700	39.94	9.87	47.6	14.36	41.67	14.69	53.27
5800	39.93	9.84	48.79	14.27	41.6	14.44	54.28
5900	39.66	9.44	47.48	14.36	41.32	13.55	54.66

Applications

- C band power amplifier
- ISM/RF Energy power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

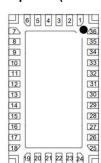
Turning the device ON

- 1. Set VGS to the pinch--off (VP) voltage, typically -5 V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level
- **Figure 1: Pin Connection definition**

Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Transparent top view (Backside grounding for source)



Pin No. Symbol		Description		
8,9,10,11	RF IN/Vgs	RF Input, Vgs bias		
32,33,34,35 RF OUT/VDD		RFOutput, Drain bias		
B 4B 4 B	ONE	DC/RF Ground. Must be soldered directly to heatsink or copper coin for		
Rest Pins and Package Base	GND	CW application.		



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Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+150	Vdc
GateSource Voltage	V _{GS}	-8 to +0.5	Vdc
Operating Voltage	V _{DD}	36	Vdc
Maximum gate current	lgs	3	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T _C	+150	°C
Operating Junction Temperature	T₃	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Doug	10	00 00
T _C = 85°C, at Pdiss=8W	R⊕JC	10	°C /W

Table 3. Electrical Characteristics (TA = 25℃ unless otherwise noted)

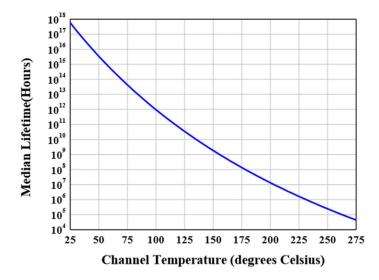
DC Characteristics (main path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=3mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 3mA	$V_{GS(th)}$	-4		-2	V
Gate Quiescent Voltage	VDS =28V, IDS=20mA, Measured in Functional Test	$V_{GS(Q)}$		-2.6		V

Ruggedness Characteristics

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	5.8GHz, Pout=12W Pulsed CW					
	All phase,	VSWR		10:1		
	No device damages					

Figure 2: Median Lifetime vs. Channel Temperature





Typical performance at 1.5GHz

Figure 3: Efficiency and power gain as function of Pout

GTAH58012C6 Class AB Vds= 28V, Idq=19.1mA PulseWidth= 20us, DutyCycle= 10%,DEMO1

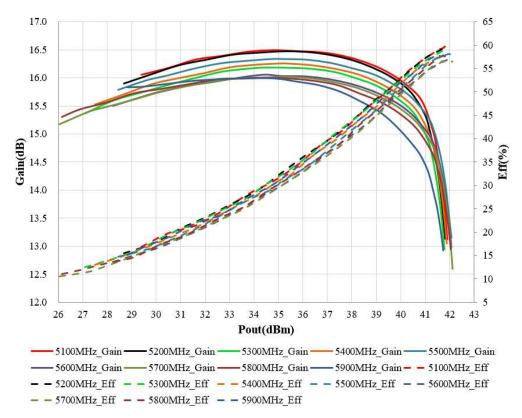


Figure 4: Network analyzer output S11/S21



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Figure 5: Picture of application board

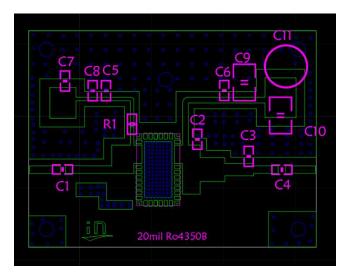
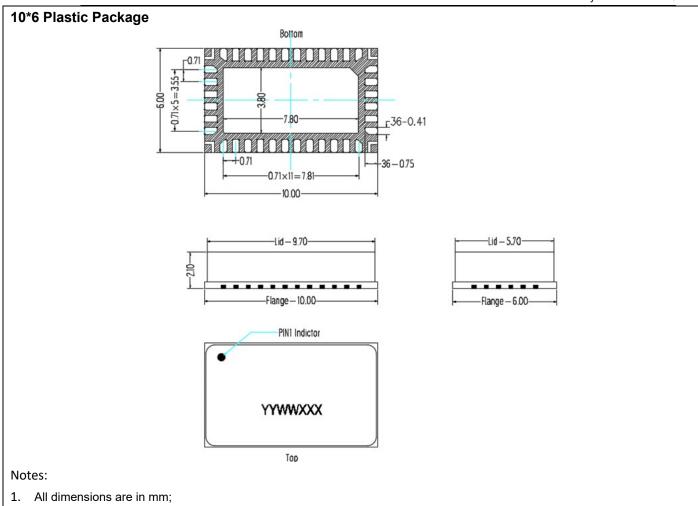


Table 4. Bill of materials of application board (PCB layout upon request, RO4350B 20mils)

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Component	Value	Quantity
U1	GTAH58012C6	1
C1、C4、C5、C6	3.3pF	4
C2、C3	0.3pF	2
C7	10nF	1
C8	1nF	1
C9、C10	10uF/63V	2
R1	10 Ω	1
C11	470uF/63V	1
	1	



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Revision history

Table 4. Document revision history

The tolerances unless specified are ±0.2mm.

Date	Revision	Datasheet Status
2024/4/26	V1.0	Preliminary Datasheet Creation

Application data based on: ZYX-24-37

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